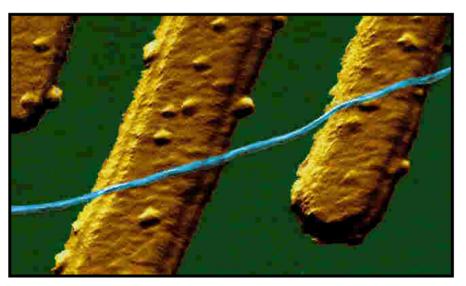
Nanomaterials

Lecture 14: Nanoelectronic Alternatives

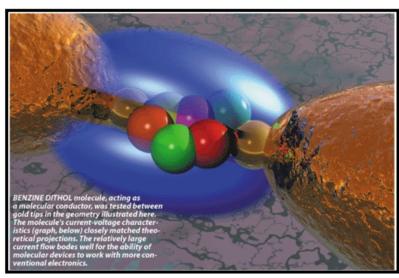
Nanoelectronic Alternatives

Carbon Nanotube Transistors



Nature, **391**, 59 (1998).

Molecular Electronics



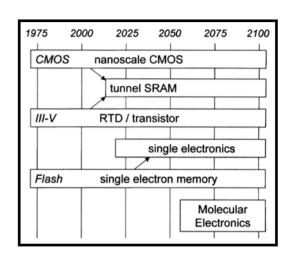
Sci. American, 282, 86 (2000).

Resonant Tunneling Diodes, Single Electron Devices, Quantum Cellular Automata, Molecular Electronics, ...

Nanoelectronic Predictions

Projected timeline for the electronics industry:

A. C. Seabaugh, P. Mazumder, *Proceedings of the IEEE*, <u>87</u>, 535 (1999).

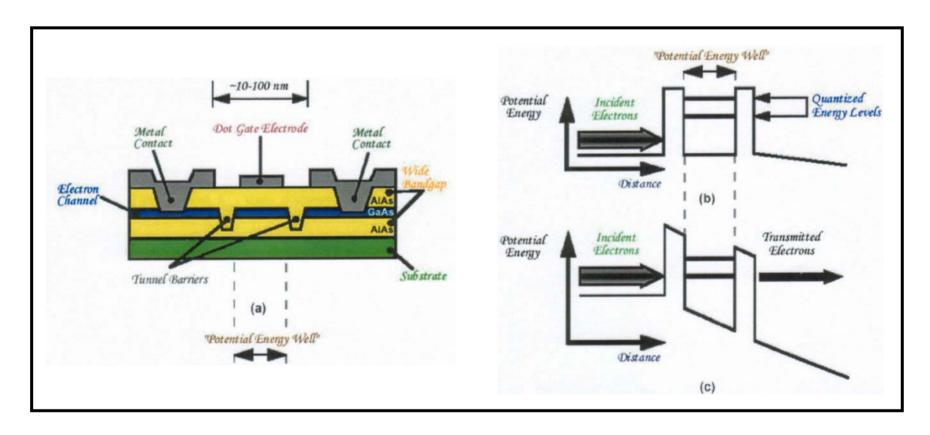




President William J. Clinton State of the Union Address January 27, 2000

"Soon researchers will bring us devices that can translate foreign languages as fast as you can talk; materials 10 times stronger than steel at a fraction of the weight; and -- this is unbelievable to me -- molecular computers the size of a tear drop with the power of today's fastest supercomputers."

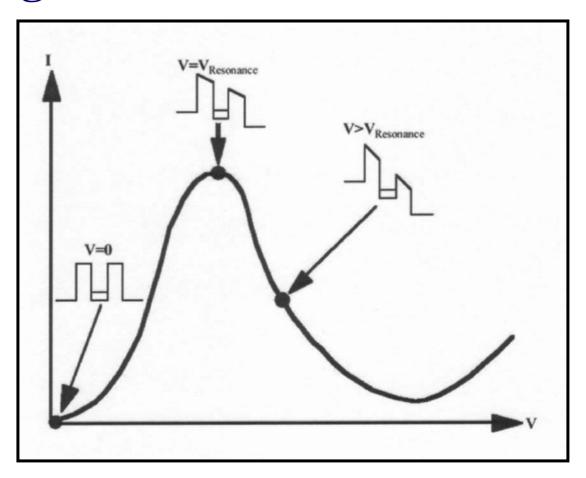
Resonant Tunneling Diode



http://courses.nus.edu.sg/course/phyweets/Projects99/Quantum

Department of Materials Science and Engineering, Northwestern University

Negative Differential Resistance



http://courses.nus.edu.sg/course/phyweets/Projects99/Quantum

Department of Materials Science and Engineering, Northwestern University

Single Electron Devices

Coulomb Blockade: Suppression of electron tunneling to an island (0-D quantum dot) by a single electron charging energy

NOTE: Capacitor charging energy = $Q^2/2C$ For a single electron $\rightarrow e^2/2C$

Two Conditions for Coulomb Blockade:

- (1) Thermal Fluctuations: $e^2/C >> kT$
- (2) Heisenberg Uncertainty: $\Delta E \Delta t >> h$ $(e^2/C)(R_tC) >> h \rightarrow R_t >> h/e^2$

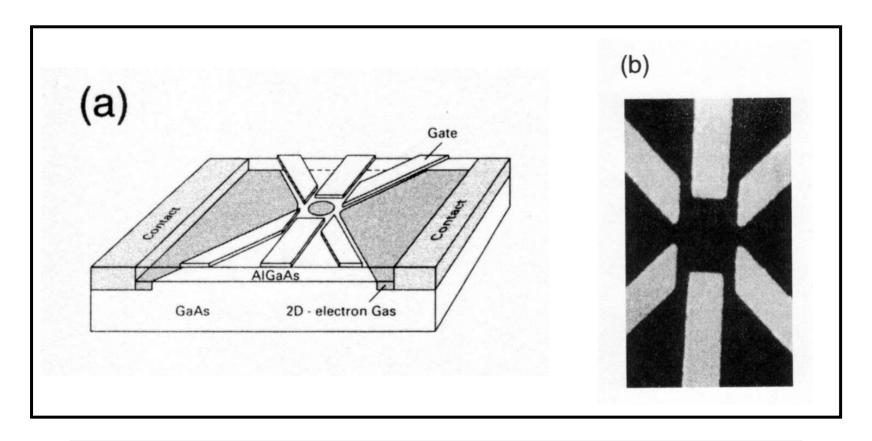
Temperature Requirement for Coulomb Blockade

Temperature Condition for Coulomb Blockade:

To suppress thermal fluctuations, $e^2/C >> kT$

- \rightarrow For room temperature operation, C ~ 1 aF = 10⁻¹⁸ F
- \rightarrow For C ~ 1 aF, quantum dot dimensions ~ 1 nm
- → Since it is challenging to fabricate down to 1 nm, most single electron devices only operate at low temperature

GaAs/AlGaAs Single Electron Device



Top gates deplete 2-DEG, thus forming a quantum dot

Coulomb Blockade I-V Characteristic

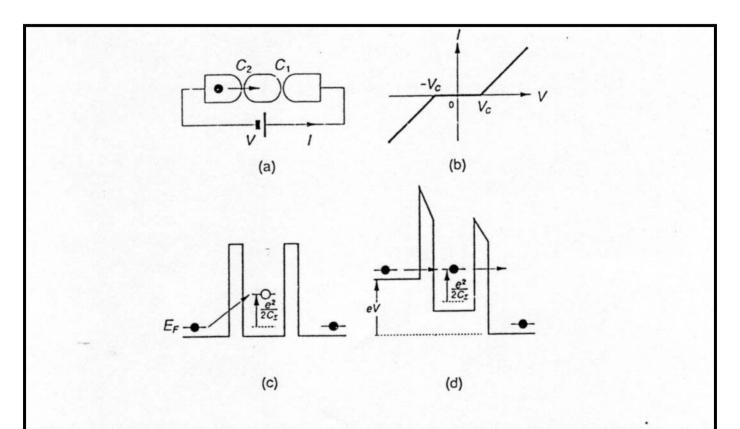


Fig. 1. (a) A one island system. (b) Coulomb blockade characteristic. (c) and (d) Energy barriers without and with applied bias. E_F is the electron fermi energy.

Single Electron Transistor

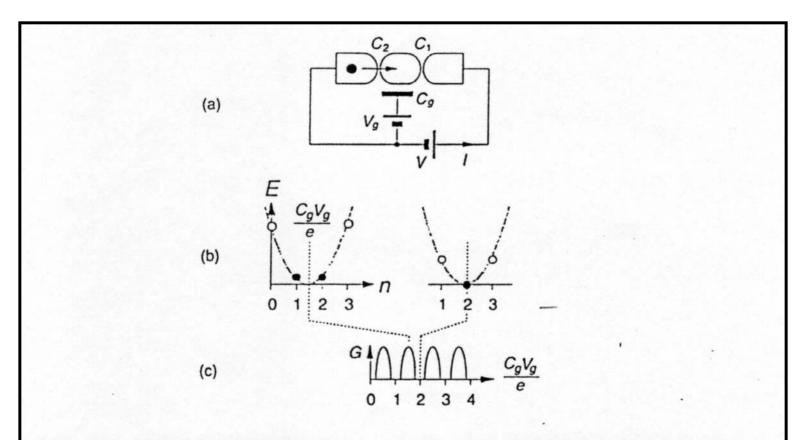


Fig. 2. Operating principle of a single electron transistor. (a) Configuration. (b) Charging energy as a function of the number of excess electrons on the central island. (c) Conductance as a function of gate voltage.

Single Electron Transistor

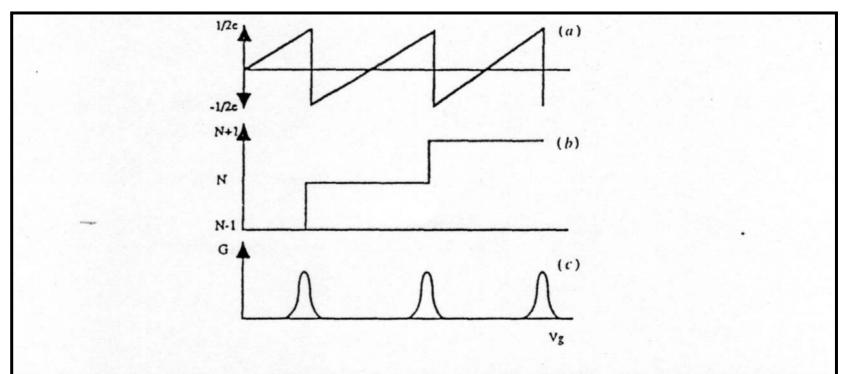


Fig. 3. A plot of: (a) charge; (b) number of electrons; and (c) conductance through a dot versus gate voltage.

Single Electronics

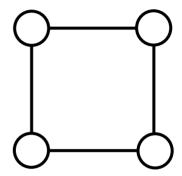
Benefits:

- (1) Low power since only one electron moves through the device
- (2) High device density is possible

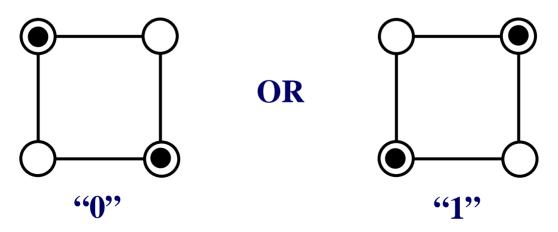
Problems:

- (1) Fabrication is difficult
- (2) Inherently slow since only one electron moves through the device
 - → Difficult to charge up capacitance at outputs (fan-out problems)
- (3) Interconnections

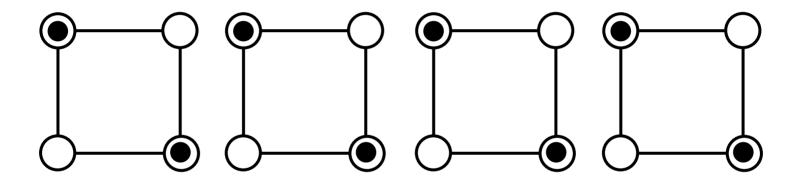
Consider four coupled quantum dots:



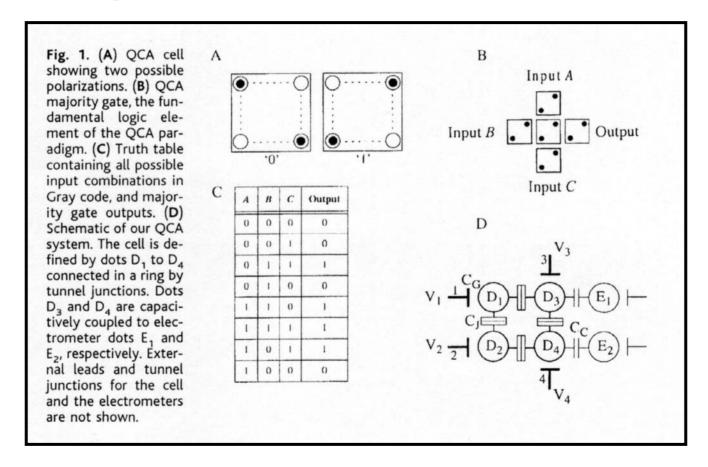
If two electrons are injected into this cell, there are two possibilities that minimize electrostatic energy:



Adjacent QCA cells align to minimize electrostatic energy:

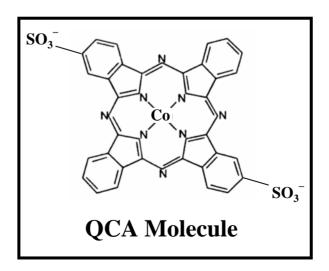


- If you switch the first cell, the other cells will follow
- → Information transfer without electron transfer
- → No interconnections are required between cells
- Intersecting QCA rows allow for logic and computation



I. Amlani, et al., Science, 284, 289 (1999).

- Although QCA minimizes the number of interconnections, it still suffers from the same thermal fluctuation problems as single electronic devices
- Consequently, QCA must be implemented at low temperatures or at molecular length scales:

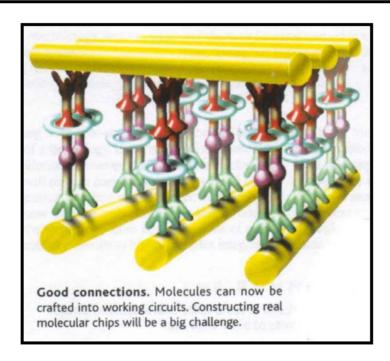


ROBERT R. McCORMICK SCHOOL OF ENGINEERING AND APPLIED SCIENCE

BREAKTHROUGH OF THE YEAR

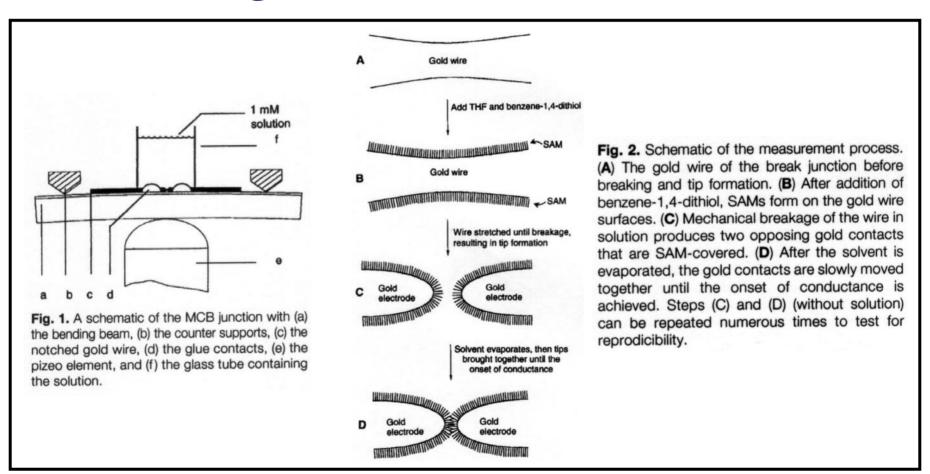
In 2001, scientists assembled molecules into basic circuits, raising hopes for a new world of nanoelectronics

Molecules Get Wired



Science, 294, 2442 (2001).

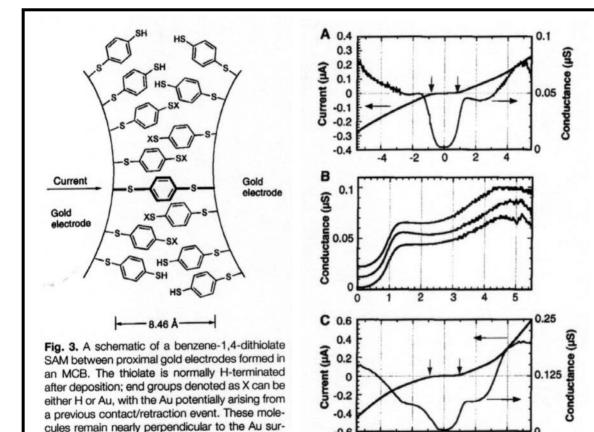
Contacting Molecules with Break Junctions



M. A. Reed, et al., Science, 278, 252 (1997).

Department of Materials Science and Engineering, Northwestern University

Room Temperature Molecular Conduction



face, making other molecular orientations unlikely

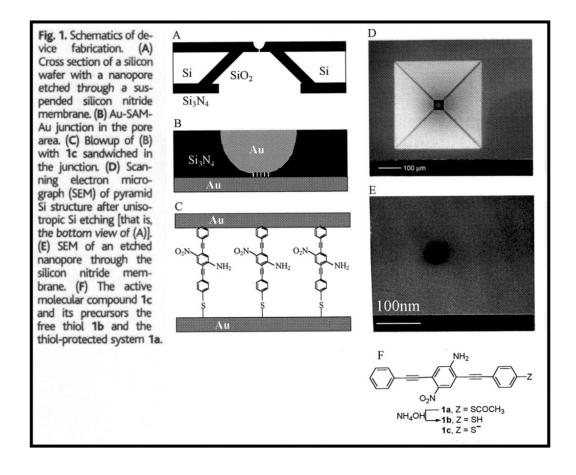
(21).

Fig. 4. (A) Typical I(V) characteristics, which illustrate a gap of 0.7 V; and the first derivative G(V), which shows a steplike structure. (B) Three independent G(V) measurements, offset for clarity, illustrating the reproducibility of the conductance values. The measurements were made with the same MCB but for different retractions/ contacts and thus different contact configurations. Offsets of 0.01 µS for the middle curve and 0.02 µS for the top curve are used for clarity. The first step for these three measurements gives values of 22.2, 22.2, and 22.7 megohm (top to bottom); the next step gives values of 12.5, 13.3, and 14.3 megohm. The middle curve is the same data as in (A). (C) An I(V) and G(V)measurement illustrating conductance values approximately twice the observed minimum conductance values. Resistances of ~14 megohm for the first step and 7.1 megohm (negative bias) and 5 megohm (positive bias) for the second step were measured.

M. A. Reed, et al., Science, 278, 252 (1997).

Voltage (V)

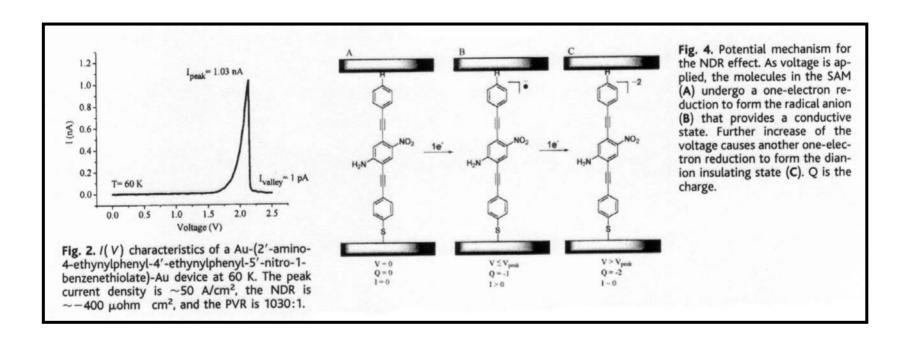
Contacting Molecules with Nanoscale Pores



J. Chen, et al., Science, 286, 1550 (1999).

Department of Materials Science and Engineering, Northwestern University

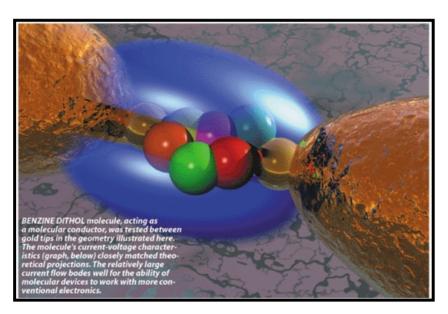
Molecular Negative Differential Resistance



J. Chen, et al., Science, 286, 1550 (1999).

Recent Molecular Electronics Research

Metal-Molecule-Metal Junctions:



Sci. American, 282, 86 (2000).

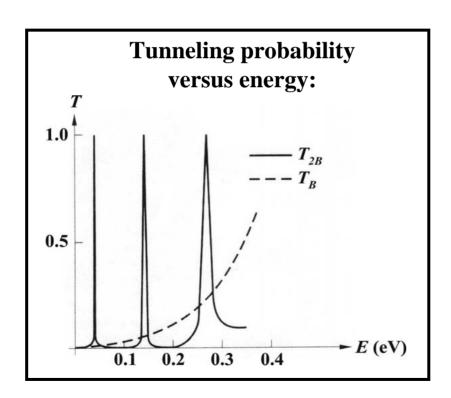
Recent results suggest that the contacts play a large – if not dominant role – in molecular electronic devices.

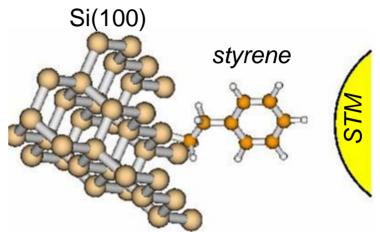
Science, 300, 1384 (2003).

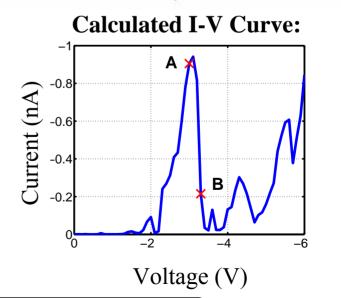
Department of Materials Science and Engineering, Northwestern University

Semiconductor-Molecule-Metal Junctions

Molecular Resonant Tunneling Diode (RTD): Negative Differential Resistance (NDR)



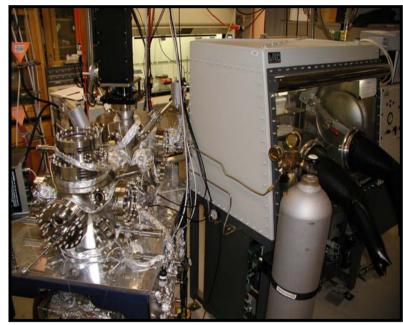




Department of Materials Science and Engineering, Northwestern University

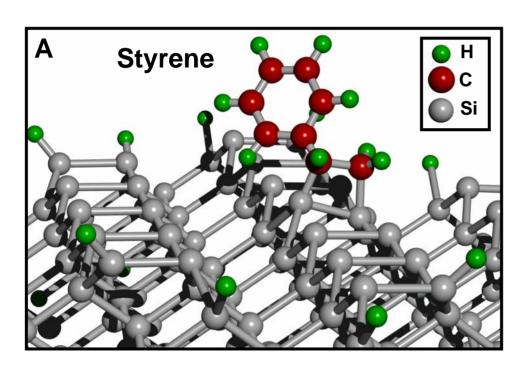
Experimental Approach



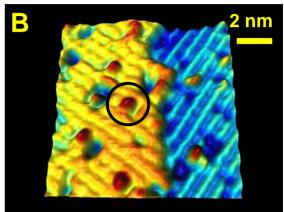


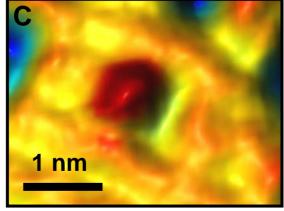
- Fundamental scanning tunneling microscopy experiments in ultra-high vacuum at room temperature
- Studies on silicon bridge the gap between fundamental research and modern technology

Styrene on the Si(100)-2×1 Surface



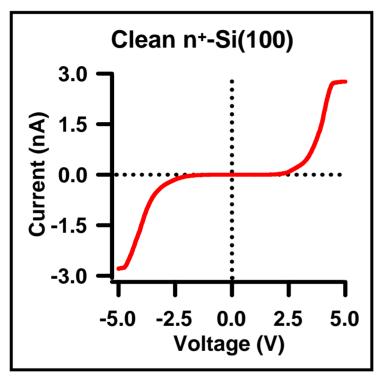
Individual styrene molecules are probed with the STM

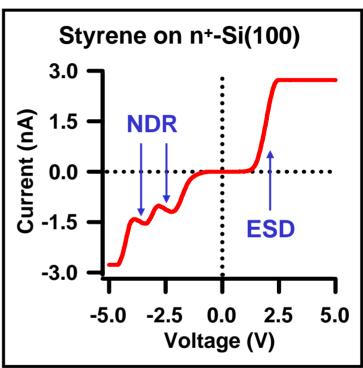




N. P. Guisinger, et al., Nano Letters, 4, 55 (2004).

I-V Curve for Styrene on n⁺-Si(100)

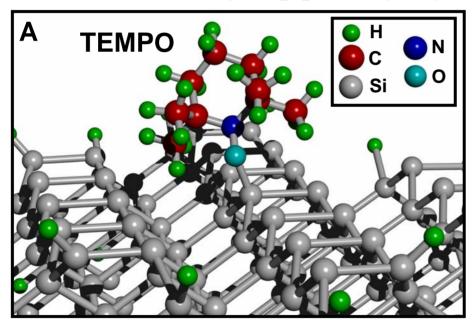


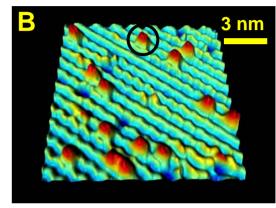


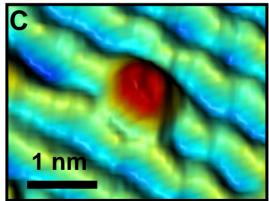
- Multiple NDR events.
- NDR is only observed at negative sample bias.
- Molecule is desorbed from the surface at positive bias.

TEMPO on the $Si(100)-2\times1$ Surface

TEMPO: (2,2,6,6-tetramethyl-1-piperidinyloxy)



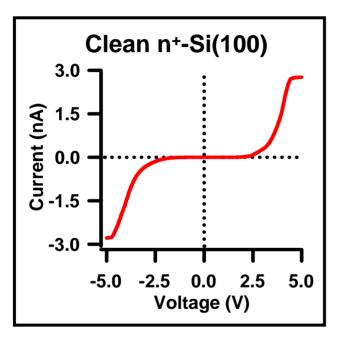


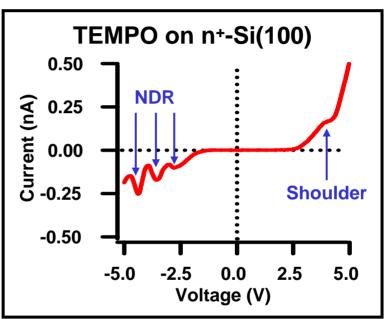


TEMPO resists electron stimulated desorption since it is a saturated hydrocarbon

N. P. Guisinger, et al., Nano Letters, 4, 55 (2004).

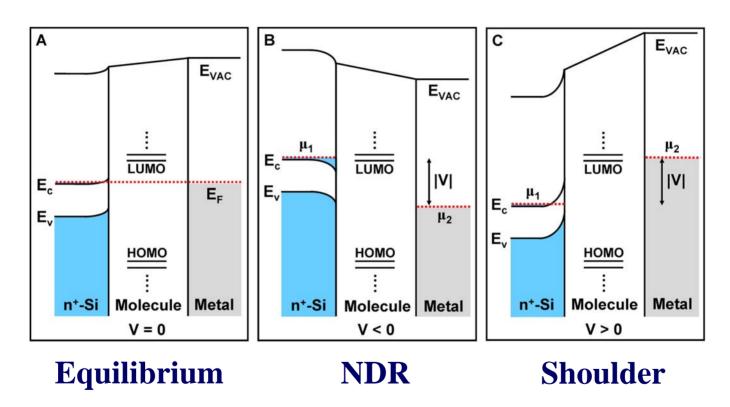
I-V Curve for TEMPO on n⁺-Si(100)





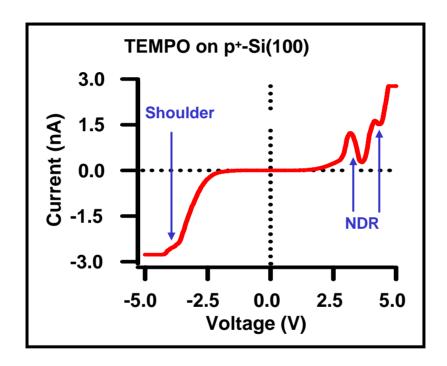
- Multiple NDR events.
- NDR is only observed at negative sample bias.
- Shoulder is only observed at positive sample bias.

Band Diagrams for Molecules on n⁺-Si(100)



For p⁺-Si(100), the behavior should be qualitatively the same, except at the opposite bias polarity.

NDR for TEMPO on p⁺-Si(100)



• Qualitatively similar behavior to TEMPO on n⁺-Si(100) except opposite polarity, as expected.

Molecular Electronics

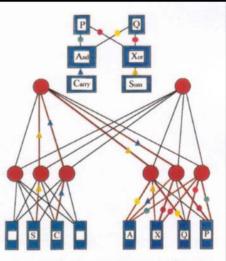
To become commercially viable, many obstacles must be overcome:

- (1) Macroscopic contacts, interconnections
- (2) Integration with conventional devices
- (3) Reliability
- (4) Reproducibility
- → Defect tolerant architectures and nanotube electronics help circumvent some of these problems

A Defect-Tolerant Computer Architecture: Opportunities for Nanotechnology

James R. Heath, Philip J. Kuekes, Gregory S. Snider, R. Stanley Williams

Fig. 3. This figure demonstrates how a particular implementation of a custom configurable computer is downloaded onto a given set of resources, and how the crossbar architecture, with sufficient bandwidth, allows for defect-tolerant computation. The blue boxes at the bottom are logic elements or memory (or both). The role of this system is to add two bits. P and Q, together to produce a Sum (S) and a Carry (C). When P and Q are the inputs to an And gate (A), then the output is the Carry. When they are inputs into an Xor gate, then the output is the Sum. Thus, both P and Q must be connected to both A and X, and the ouput of A and X must be connected to the memory locations for S and C, respectively. The red circles are crossbars, and there are two levels to this fat tree. This particular logical implementation illustrates how various components with widely varying numbers of defect can still be used to construct a working system. From the bottom left crossbar, and proceeding clockwise, we use 20, 70, 0, and



80% of the available resources. Similar arguments can be made for the other components. To understand this system more completely, it is advisable to reassign the look-up tables differently, define some of the crossbar switches to be defective and thus removed from the available resources, and then reconnect the system to enable the adder. Such an exercise is very similar to what the compiler does when it downloads the logical architecture onto the available resources.

J. R. Heath, et al., Science, 280, 1716 (1998).